

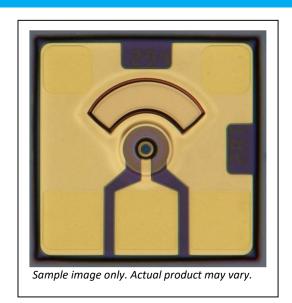
100 Gbit/s VCSEL (880 nm) Contact type: GSG

Product Code:

V50-880-GSG-C1 1x1

V50-880-GSG-C4 4x1

Engineering Samples *Preliminary datasheet*



Product Description

These compact and very high modulation rate top-emitting GaAs-based vertical cavity surface emitting laser (VCSEL) chips are available as engineering samples for use in the development and evaluation of optical interconnections, optical backplanes and integrated waveguides, and next-generation optical data communications systems. The VCSELs are contacted on the top-surface individually using ground-source-ground (GSG) microprobes or wire bonds.

Optical aperture: ~5-7µm

Features

- · Up to 112 Gbit/s (PAM-4 modulation)
- · Single chip size 250 x 250 µm
- · Suitable for wire bonding

Applications

- · 200G / 400G in SWDM
- · Proprietary optical interconnects
- · Active Optical Cables (AOC)

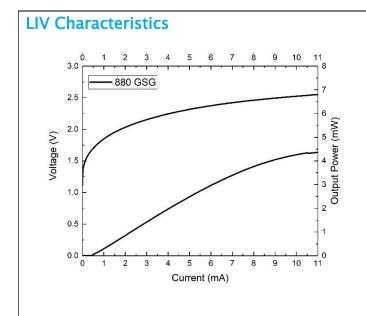
Parameter	Typical	Notes
Emission wavelength	880 nm	(range 870 – 890 nm)
Data rate	Up to 112 Gbit/s	56 GBaud/s PAM-4
Threshold current	< 0.6 mA	
Peak output power	4 mW	

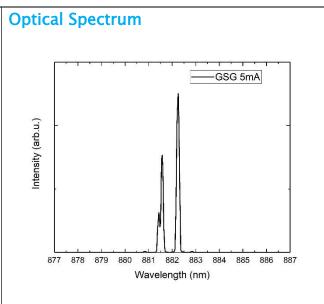


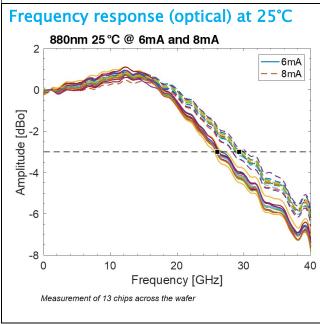
Vertically Integrated Systems

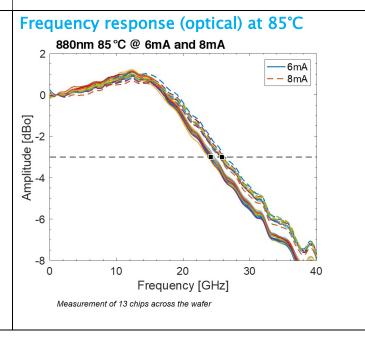
Electro-Optical Specifications (T = 0 to 85°C)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Emission wavelength	λ		870		890	nm
Data rate	BR	PAM-4		50	56	GBaud/s
Optical bandwidth	BW (f3dBo)	6 mA		25	30	GHz
Slope efficiency	η	5-10 mA		0.5	0.6	W/A
Threshold current	lth			0.5		mA
Differential resistance	Rd	5-10 mA		50	60	Ω
Beam divergence	Θ	1/e ²		30		0
Peak output power	Pmax			4		mW
Spectral bandwidth (RMS)	$\Delta \lambda_{RMS}$			0.6	0.65	nm









Test Equipment: Keysight VNA



Vertically Integrated Systems

Absolute Maximum Ratings

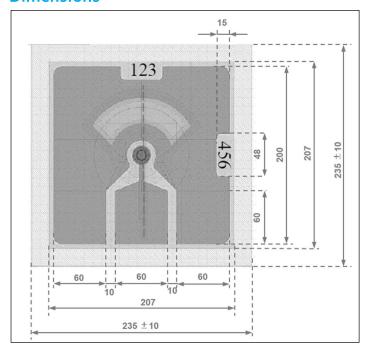
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Peak forward current	lf				8	mA
Maximum reverse voltage	V_{rv}				5	V
Operating temperature	T_{op}				85	°C
Storage temperature	T_{st}		-40		100	°C
Soldering temperature	T_{sl}	max 260 sec			150	°C

Stress in excess of any of the individual Absolute Maximum Ratings can cause immediate irreversible damage to the component even if all other parameters are within the electro-optical specifications. Exposure to any of the Absolute Maximum Ratings for extended periods can adversely affect the reliability of these chips.

Mechanical Dimensions

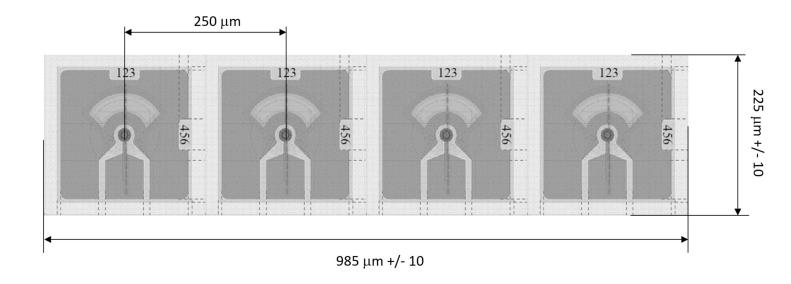
Parameter	Туре	Min	Тур	Max	Unit
VCSEL pitch			250		μm
Length			210	250	μm
Height		140	150	160	μm
Width			210	250	μm

Dimensions





V50-880-GSG-C4 Array dimensions



Qualification Notification

The VM100-880-GSG-Cxx has been tested to meet specifications outlined in this data sheet at room temperature. However, it has not undergone full qualification testing or characterization and therefore may not meet the performance specifications over all extremes.





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